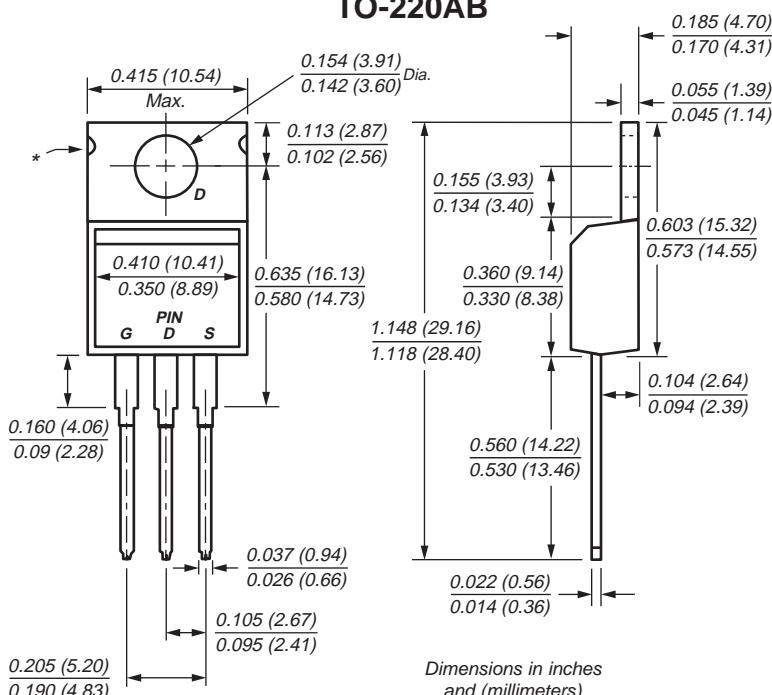


TRENCH  
GENFET®

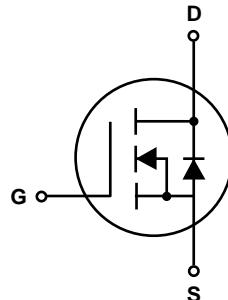
## N-Channel Enhancement-Mode MOSFET

V<sub>DS</sub> 30V R<sub>DS(ON)</sub> 13mΩ I<sub>D</sub> 50A

**TO-220AB**



\* May be notched or flat



### Features

- Advanced Process Technology
- High Density Cell Design for Ultra Low On-Resistance
- Specially Designed for Low Voltage DC/DC Converters
- Fast Switching for High Efficiency

### Mechanical Data

**Case:** JEDEC TO-220AB molded plastic body

**Terminals:** Leads solderable per MIL-STD-750, Method 2026

**High temperature soldering guaranteed:**  
250°C/10 seconds at terminals

**Mounting Torque:** 10 in-lbs maximum

**Weight:** 2.0g

### Maximum Ratings and Thermal Characteristics (T<sub>C</sub> = 25°C unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	30	V
Gate-Source Voltage		V <sub>GS</sub>	±20	
Continuous Drain Current <sup>(1)</sup>		I <sub>D</sub>	50	A
Pulsed Drain Current		I <sub>DM</sub>	100	
Maximum Power Dissipation	T <sub>C</sub> = 25°C T <sub>C</sub> = 100°C	P <sub>D</sub>	62.5 25	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C
Lead Temperature (1/8" from case for 5 sec.)		T <sub>L</sub>	275	°C
Junction-to-Case Thermal Resistance		R <sub>θJC</sub>	2.0	°C/W
Junction-to-Ambient Thermal Resistance		R <sub>θJA</sub>	62.5	°C/W

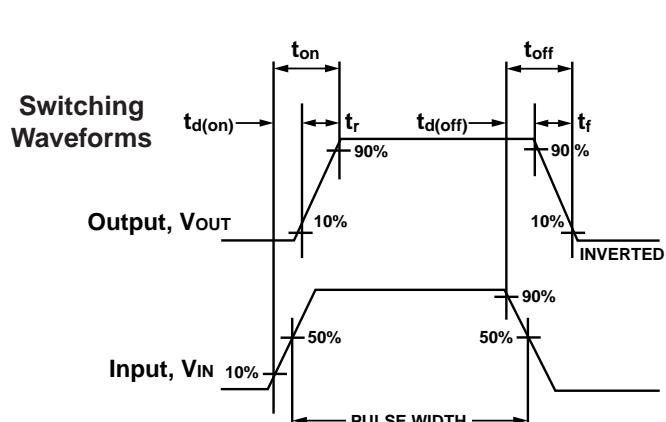
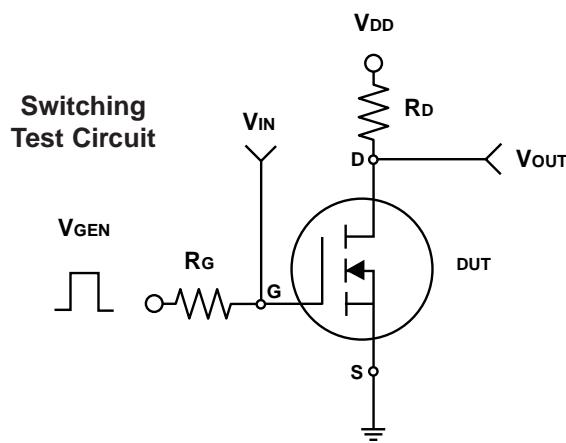
**Notes:** (1) Maximum DC current limited by the package

**N-Channel Enhancement-Mode MOSFET**
**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = 250\mu\text{A}$	30	—	—	V
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = 250\mu\text{A}$	1.0	—	3.0	
Gate-Body Leakage	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{DS}} = 0\text{V}, \text{V}_{\text{GS}} = \pm 20\text{V}$	—	—	$\pm 100$	$\text{nA}$
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}} = 30\text{V}, \text{V}_{\text{GS}} = 0\text{V}$	—	—	1	$\mu\text{A}$
On-State Drain Current <sup>(1)</sup>	$\text{I}_{\text{D(on)}}$	$\text{V}_{\text{DS}} \geq 5\text{V}, \text{V}_{\text{GS}} = 10\text{V}$	60	—	—	A
Drain-Source On-State Resistance <sup>(1)</sup>	$\text{R}_{\text{DS(on)}}$	$\text{V}_{\text{GS}} = 10\text{V}, \text{I}_D = 25\text{A}$	—	11	13	$\text{m}\Omega$
		$\text{V}_{\text{GS}} = 4.5\text{V}, \text{I}_D = 20\text{A}$	—	15	20	
Forward Transconductance <sup>(1)</sup>	$\text{g}_{\text{fs}}$	$\text{V}_{\text{DS}} = 10\text{V}, \text{I}_D = 25\text{A}$	—	40	—	S
Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{I}_S = 25\text{A}, \text{V}_{\text{GS}} = 0\text{V}$	—	0.9	1.3	V
<b>Dynamic<sup>(1)</sup></b>						
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}} = 15\text{V}, \text{V}_{\text{GS}} = 5\text{V}, \text{I}_D = 50\text{A}$	—	16	22	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$	$\text{V}_{\text{DS}} = 15\text{V}, \text{V}_{\text{GS}} = 10\text{V}$ $\text{I}_D = 50\text{A}$	—	35	60	
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		—	8	—	
Turn-On Delay Time	$\text{t}_{\text{d(on)}}$		—	11	20	
Rise Time	$\text{t}_r$	$\text{V}_{\text{DD}} = 15\text{V}, \text{R}_L = 15\Omega$ $\text{I}_D \approx 1\text{A}, \text{V}_{\text{GEN}} = 10\text{V}$ $\text{R}_G = 6\Omega$	—	11	20	ns
Turn-Off Delay Time	$\text{t}_{\text{d(off)}}$		—	48	80	
Fall Time	$\text{t}_f$		—	15	30	
Input Capacitance	$\text{C}_{\text{iss}}$		—	1850	—	pF
Output Capacitance	$\text{C}_{\text{oss}}$	$\text{V}_{\text{DS}} = 15\text{V}$ $f = 1.0\text{MHz}$	—	315	—	
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		—	145	—	
Source-Drain Reverse Recovery Time	$\text{t}_{\text{rr}}$	$\text{I}_F = 25\text{A}, \frac{\text{d}i}{\text{d}t} = 100\text{A}/\mu\text{s}$	—	160	—	ns

**Note:**

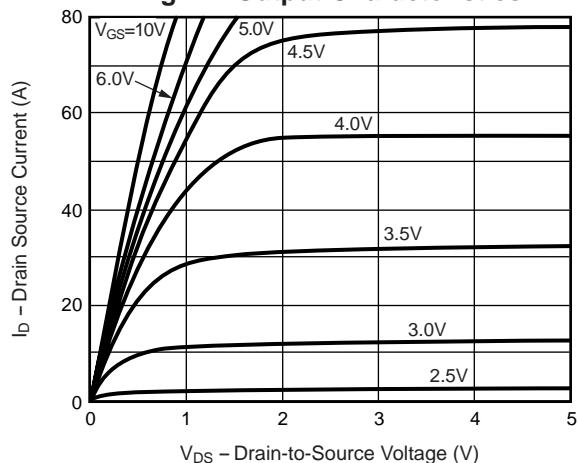
(1) Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$



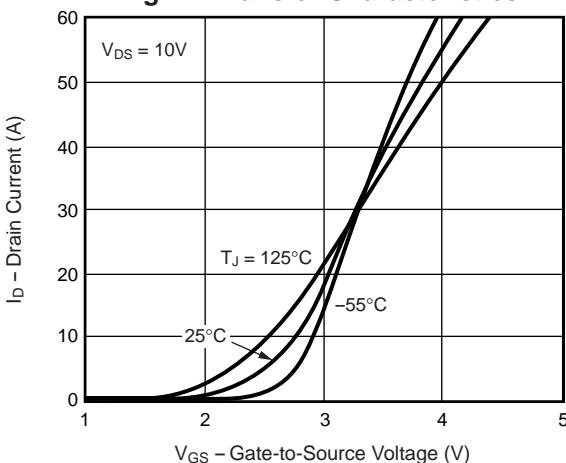
## N-Channel Enhancement-Mode MOSFET

### Ratings and Characteristic Curves ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

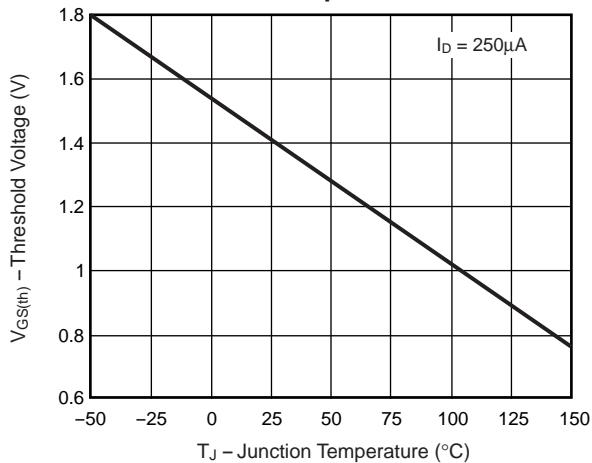
**Fig. 1 – Output Characteristics**



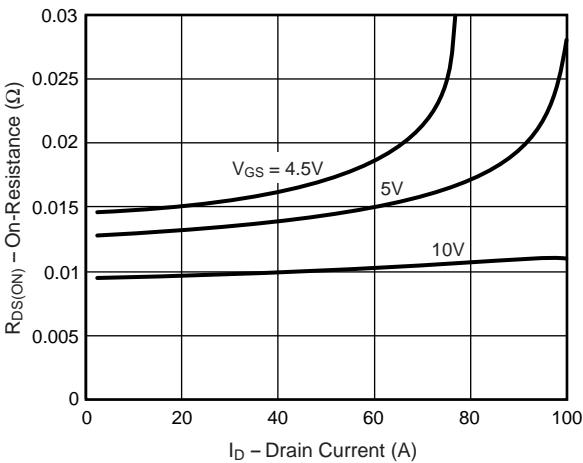
**Fig. 2 – Transfer Characteristics**



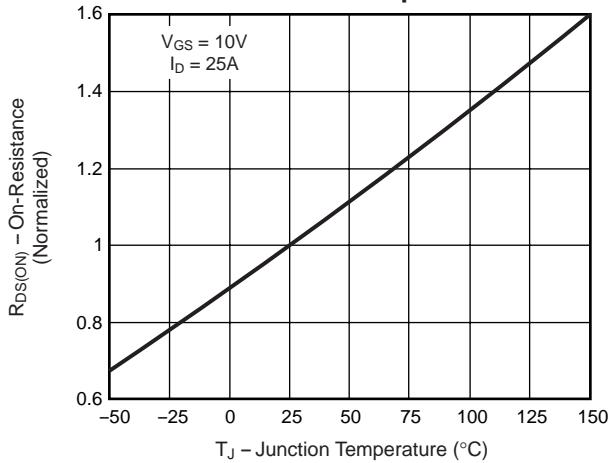
**Fig. 3 – Threshold Voltage  
vs. Temperature**



**Fig. 4 – On-Resistance  
vs. Drain Current**



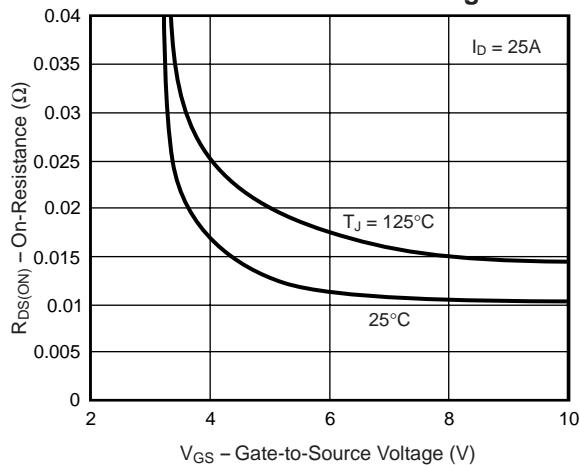
**Fig. 5 – On-Resistance  
vs. Junction Temperature**



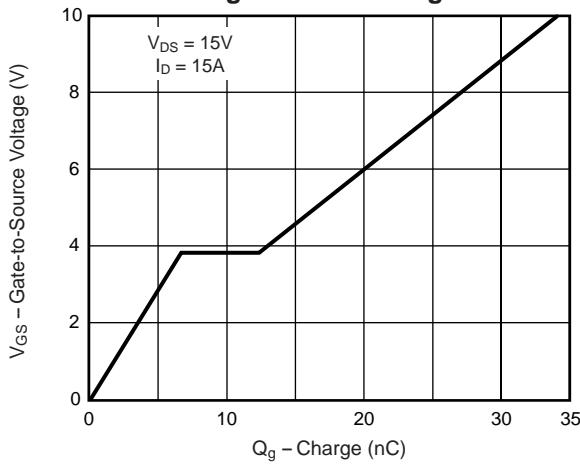
# N-Channel Enhancement-Mode MOSFET

## Ratings and Characteristic Curves ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

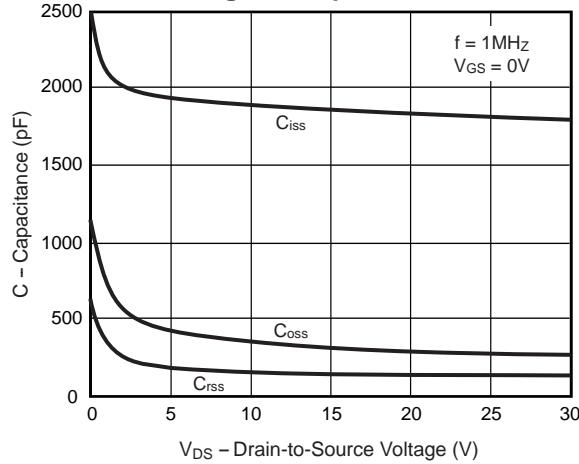
**Fig. 6 – On-Resistance vs. Gate-to-Source Voltage**



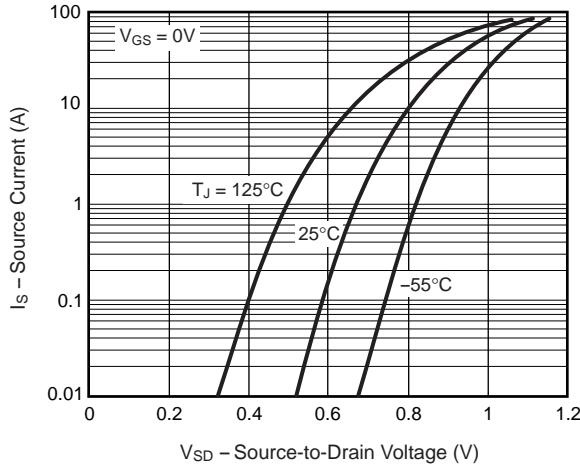
**Fig. 7 – Gate Charge**



**Fig. 8 – Capacitance**



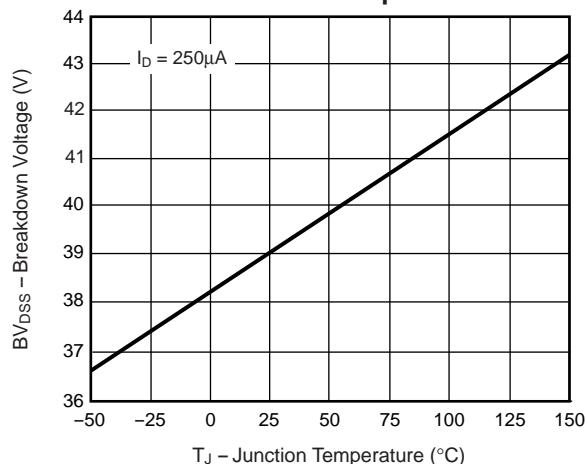
**Fig. 9 – Source-Drain Diode Forward Voltage**



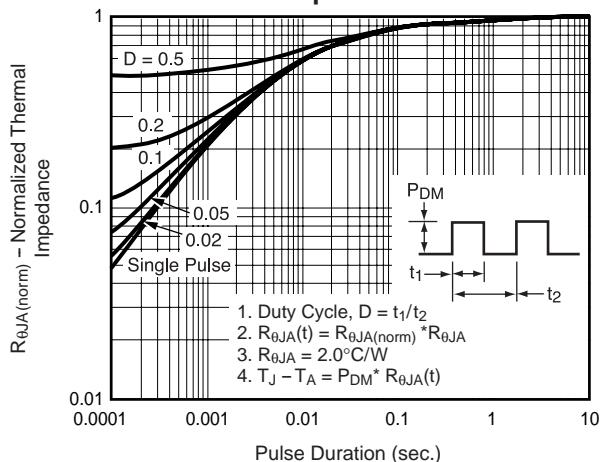
## N-Channel Enhancement-Mode MOSFET

### Ratings and Characteristic Curves (TA = 25°C unless otherwise noted)

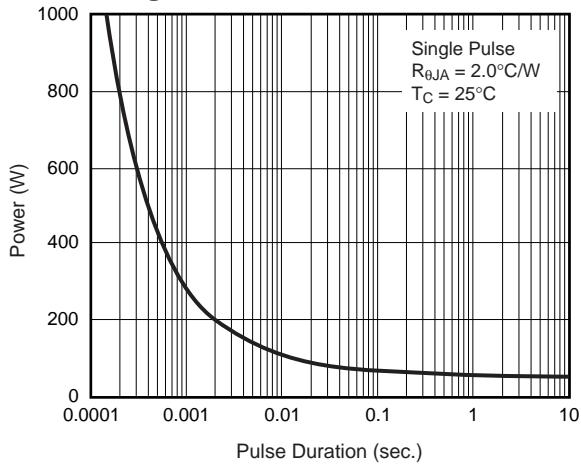
**Fig. 10 – Breakdown Voltage vs. Junction Temperature**



**Fig. 11 – Transient Thermal Impedance**



**Fig. 12 – Power vs. Pulse Duration**



**Fig. 13 – Maximum Safe Operating Area**

